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Applications of "<u>Embedded -</u> <u>Microcontrollers</u>"

Details

Product Status	Obsolete
Core Processor	ARM® Cortex®-M3
Core Size	32-Bit Single-Core
Speed	48MHz
Connectivity	I ² C, IrDA, SPI, UART/USART
Peripherals	Brown-out Detect/Reset, DMA, POR, PWM, WDT
Number of I/O	79
Program Memory Size	256KB (256K x 8)
Program Memory Type	FLASH
EEPROM Size	-
RAM Size	24K x 8
Voltage - Supply (Vcc/Vdd)	1.62V ~ 3.6V
Data Converters	A/D 16x10b; D/A 1x10b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	100-TFBGA
Supplier Device Package	100-TFBGA (9x9)
Purchase URL	https://www.e-xfl.com/product-detail/atmel/atsam3n4ca-cu

Email: info@E-XFL.COM

Address: Room A, 16/F, Full Win Commercial Centre, 573 Nathan Road, Mongkok, Hong Kong

1.1 Configuration Summary

The SAM3N4/2/1/0/00 differ in memory size, package and features list. Table 1-1 summarizes the configurations of the 9 devices.

Table 1-1.Configuration Summary

Device	Flash	SRAM	Package	Number of PIOs	ADC	Timer	PDC Channels	USART	DAC
SAM3N4A	256 Kbytes	24 Kbytes	LQFP48 QFN48	34	8 channels	6 ⁽¹⁾	8	1	_
SAM3N4B	256 Kbytes	24 Kbytes	LQFP64 QFN64	47	10 channels	6 ⁽²⁾	10	2	1
SAM3N4C	256 Kbytes	24 Kbytes	LQFP100 BGA100	79	16 channels	6	10	2	1
SAM3N2A	128 Kbytes	16 Kbytes	LQFP48 QFN48	34	8 channels	6 ⁽¹⁾	8	1	_
SAM3N2B	128 Kbytes	16 Kbytes	LQFP64 QFN64	47	10 channels	6(⁽²⁾	10	2	1
SAM3N2C	128 Kbytes	16 Kbytes	LQFP100 BGA100	79	16 channels	6	10	2	1
SAM3N1A	64 Kbytes	8 Kbytes	LQFP48 QFN48	34	8 channels	6 ⁽¹⁾	8	1	_
SAM3N1B	64 Kbytes	8 Kbytes	LQFP64 QFN64	47	10 channels	6 ⁽²⁾	10	2	1
SAM3N1C	64 Kbytes	8 Kbytes	LQFP100 BGA100	79	16 channels	6	10	2	1
SAM3N0A	32 Kbytes	8 Kbytes	LQFP48 QFN48	34	8 channels	6 ⁽¹⁾	8	1	_
SAM3N0B	32 Kbytes	8 Kbytes	LQFP64 QFN64	47	10 channels	6 ⁽²⁾	10	2	1
SAM3N0C	32 Kbytes	8 Kbytes	LQFP100 BGA100	79	16 channels	6	10	2	1
SAM3N00A	16 Kbytes	4 KBytes	LQFP48 QFN48	34	8 channels	6 ⁽¹⁾	8	1	_
SAM3N00B	16 Kbytes	4 KBytes	LQFP64 QFN64	47	10 channels	6 ⁽²⁾	10	2	1

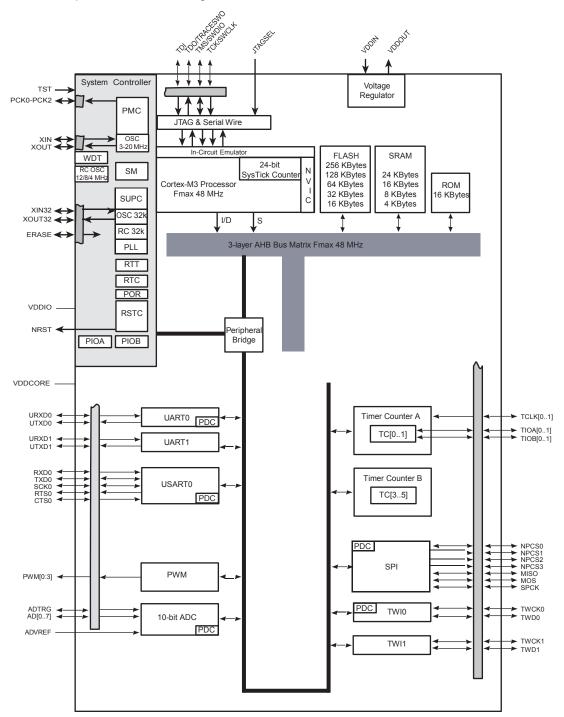
Notes: 1. Only two TC channels are accessible through the PIO.

2. Only three TC channels are accessible through the PIO.





Figure 2-3. SAM3N 48-pin version Block Diagramz



3. Signal Description

Table 3-1 gives details on the signal name classified by peripheral.

Table 3-1.Signal Description List

Signal Name	Function	Туре	Active Level	Voltage Reference	Comments
	Power S	upplies			
VDDIO	Peripherals I/O Lines Power Supply	Power			1.62V to 3.6V
VDDIN	Voltage Regulator, ADC and DAC Power Supply	Power			1.8V to 3.6V ⁽³⁾
VDDOUT	Voltage Regulator Output	Power			1.8V Output
VDDPLL	Oscillator and PLL Power Supply	Power			1.65 V to 1.95V
VDDCORE	Power the core, the embedded memories and the peripherals	Power			1.65V to 1.95V Connected externally to VDDOUT
GND	Ground	Ground			
	Clocks, Oscilla	tors and PLLs			
XIN	Main Oscillator Input	Input			Reset State:
XOUT	Main Oscillator Output	Output			- PIO Input
XIN32	Slow Clock Oscillator Input	Input			- Internal Pull-up disabled
XOUT32	Slow Clock Oscillator Output	Output		_	- Schmitt Trigger enabled ⁽¹⁾
PCK0 - PCK2	Programmable Clock Output	Output		VDDIO	Reset State: - PIO Input - Internal Pull-up enabled - Schmitt Trigger enabled ⁽¹⁾
	ICE and	I JTAG			
TCK/SWCLK	Test Clock/Serial Wire Clock	Input			Reset State:
TDI	Test Data In	Input		1	- SWJ-DP Mode
TDO/TRACESWO	Test Data Out/Trace Asynchronous Data Out	Output		VDDIO	- Internal pull-up disabled
TMS/SWDIO	Test Mode Select /Serial Wire Input/Output	Input / I/O			- Schmitt Trigger enabled ⁽¹⁾
JTAGSEL	JTAG Selection	Input	High		Permanent Internal pull-down





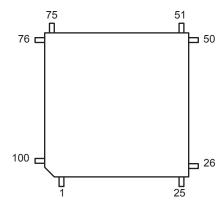
4. Package and Pinout

SAM3N4/2/1/0/00 series is pin-to-pin compatible with SAM3S products. Furthermore SAM3N4/2/1/0/00 devices have new functionalities referenced in italic inTable 4-1, Table 4-3 and Table 4-4.

4.1 SAM3N4/2/1/0/00C Package and Pinout

4.1.1 100-lead LQFP Package Outline

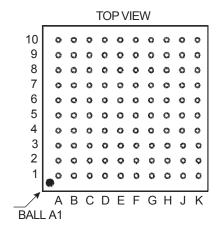
Figure 4-1. Orientation of the 100-lead LQFP Package



4.1.2 100-ball TFBGA Package Outline

The 100-Ball TFBGA package has a 0.8 mm ball pitch and respects Green Standards. Its dimensions are $9 \times 9 \times 1.1$ mm.

Figure 4-2. Orientation of the 100-ball TFBGA Package



4.2 SAM3N4/2/1/0/00B Package and Pinout

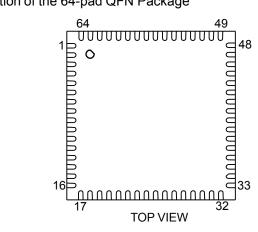


Figure 4-3. Orientation of the 64-pad QFN Package

Figure 4-4. Orientation of the 64-lead LQFP Package

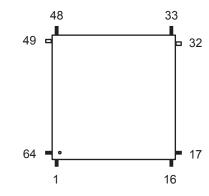






Figure 5-1. Single Supply

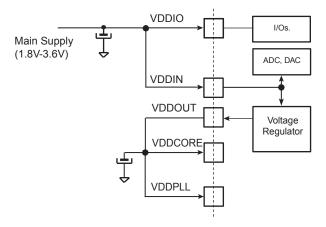
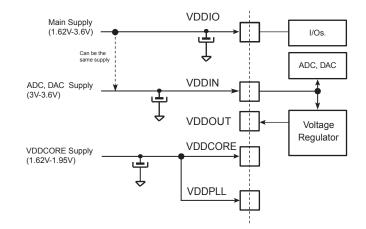


Figure 5-2. Core Externally Supplied



Note: Restrictions

With Main Supply < 3V, ADC and DAC are not usable. With Main Supply >= 3V, all peripherals are usable.

Figure 5-3 below provides an example of the powering scheme when using a backup battery. Since the PIO state is preserved when in backup mode, any free PIO line can be used to switch off the external regulator by driving the PIO line at low level (PIO is input, pull-up enabled after backup reset). External wake-up of the system can be from a push button or any signal. See Section 5.6 "Wake-up Sources" for further details.TFBGA

SAM3N Summary

7. Processor and Architecture

7.1 ARM Cortex-M3 Processor

- Version 2.0
- Thumb-2 (ISA) subset consisting of all base Thumb-2 instructions, 16-bit and 32-bit.
- Harvard processor architecture enabling simultaneous instruction fetch with data load/store.
- Three-stage pipeline.
- Single cycle 32-bit multiply.
- · Hardware divide.
- Thumb and Debug states.
- Handler and Thread modes.
- · Low latency ISR entry and exit.

7.2 APB/AHB Bridge

The SAM3N4/2/1/0/00 product embeds one peripheral bridge:

The peripherals of the bridge are clocked by MCK.

7.3 Matrix Masters

The Bus Matrix of the SAM3N product manages 3 masters, which means that each master can perform an access concurrently with others, to an available slave.

Each master has its own decoder, which is defined specifically for each master. In order to simplify the addressing, all the masters have the same decodings.

Table 7-1.List of Bus Matrix Masters	
--------------------------------------	--

Master 0	Cortex-M3 Instruction/Data
Master 1	Cortex-M3 System
Master 2	Peripheral DMA Controller (PDC)

7.4 Matrix Slaves

The Bus Matrix of the SAM3N product manages 4 slaves. Each slave has its own arbiter, allowing a different arbitration per slave.

Table 7-2. List of Bus Matrix Slaves

Slave 0	Internal SRAM
Slave 1	Internal ROM
Slave 2	Internal Flash
Slave 3	Peripheral Bridge





7.5 Master to Slave Access

All the Masters can normally access all the Slaves. However, some paths do not make sense, for example allowing access from the Cortex-M3 S Bus to the Internal ROM. Thus, these paths are forbidden or simply not wired, and shown as "-" in Table 7-3.

Table 7-3.	SAM3N Master to Slave Access	i
	Masters	0

	Masters	0	1	2
	Slaves	Cortex-M3 I/D Bus	Cortex-M3 S Bus	PDC
0	Internal SRAM	-	х	Х
1	Internal ROM	Х	-	Х
2	Internal Flash	Х	-	-
3	Peripheral Bridge	-	х	Х

7.6 Peripheral DMA Controller

- · Handles data transfer between peripherals and memories
- Low bus arbitration overhead
 - One Master Clock cycle needed for a transfer from memory to peripheral
 - Two Master Clock cycles needed for a transfer from peripheral to memory
- · Next Pointer management for reducing interrupt latency requirement

The Peripheral DMA Controller handles transfer requests from the channel according to the following priorities (Low to High priorities):

Instance name	Channel T/R	100 & 64 Pins	48 Pins
TWI0	Transmit	x	х
UART0	Transmit	x	х
USART0	Transmit	x	Х
DAC	Transmit	x	N/A
SPI	Transmit	x	х
TWIO	Receive	x	х
UART0	Receive	x	х
USART0	Receive	x	х
ADC	Receive	x	х
SPI	Receive	x	х

Table 7-4. Peripheral DMA Controller

SAM3N Summary

9.1.3.9 Fast Flash Programming Interface

The Fast Flash Programming Interface allows programming the device through either a serial JTAG interface or through a multiplexed fully-handshaked parallel port. It allows gang programming with market-standard industrial programmers.

The FFPI supports read, page program, page erase, full erase, lock, unlock and protect commands.

The Fast Flash Programming Interface is enabled and the Fast Programming Mode is entered when TST and PA0 and PA1are tied low.

9.1.3.10 SAM-BA Boot

The SAM-BA Boot is a default Boot Program which provides an easy way to program in-situ the on-chip Flash memory.

The SAM-BA Boot Assistant supports serial communication via the UART0.

The SAM-BA Boot provides an interface with SAM-BA Graphic User Interface (GUI).

The SAM-BA Boot is in ROM and is mapped in Flash at address 0x0 when GPNVM bit 1 is set to 0.

9.1.3.11 GPNVM Bits

The SAM3N features three GPNVM bits that can be cleared or set respectively through the commands "Clear GPNVM Bit" and "Set GPNVM Bit" of the EEFC User Interface.

GPNVMBit[#]	Function
0	Security bit
1	Boot mode selection

9.1.4 Boot Strategies

The system always boots at address 0x0. To ensure a maximum boot possibilities the memory layout can be changed via GPNVM.

A general purpose NVM (GPNVM) bit is used to boot either on the ROM (default) or from the Flash.

The GPNVM bit can be cleared or set respectively through the commands "Clear General-purpose NVM Bit" and "Set General-purpose NVM Bit" of the EEFC User Interface.

Setting the GPNVM Bit 1 selects the boot from the Flash, clearing it selects the boot from the ROM. Asserting ERASE clears the GPNVM Bit 1 and thus selects the boot from the ROM by default.

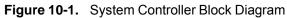


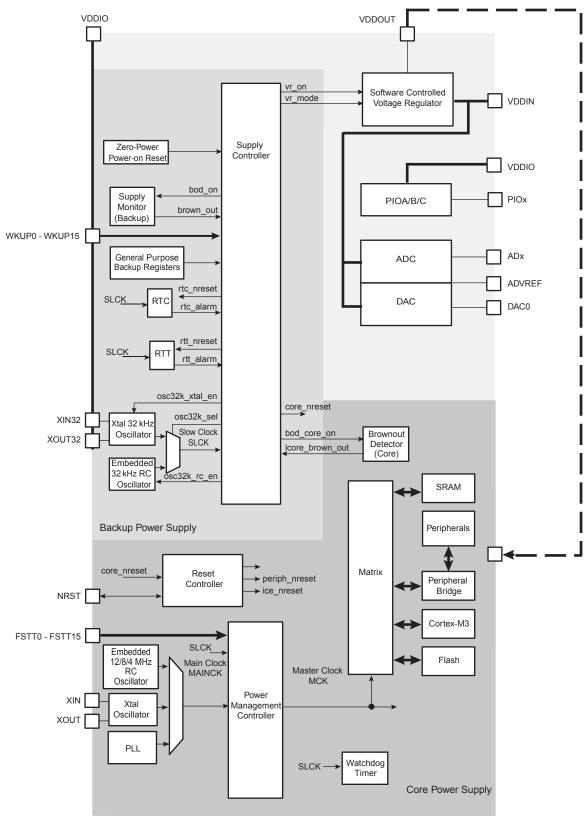


10. System Controller

The System Controller is a set of peripherals, which allow handling of key elements of the system, such as power, resets, clocks, time, interrupts, watchdog, etc...

See the System Controller block diagram in Figure 10-1 on page 35.





FSTT0 - FSTT15 are possible Fast Startup Sources, generated by WKUP0-WKUP15 Pins, but are not physical pins.





10.1 System Controller and Peripherals Mapping

Please refer to Figure 8-1, "SAM3N4/2/1/0/00 Product Mapping" on page 30.

All the peripherals are in the bit band region and are mapped in the bit band alias region.

10.2 Power-on-Reset, Brownout and Supply Monitor

The SAM3N embeds three features to monitor, warn and/or reset the chip:

- Power-on-Reset on VDDIO
- Brownout Detector on VDDCORE
- Supply Monitor on VDDIO

10.2.1 Power-on-Reset

The Power-on-Reset monitors VDDIO. It is always activated and monitors voltage at start up but also during power down. If VDDIO goes below the threshold voltage, the entire chip is reset. For more information, refer to the Electrical Characteristics section of the datasheet.

10.2.2 Brownout Detector on VDDCORE

The Brownout Detector monitors VDDCORE. It is active by default. It can be deactivated by software through the Supply Controller (SUPC_MR). It is especially recommended to disable it during low-power modes such as wait or sleep modes.

If VDDCORE goes below the threshold voltage, the reset of the core is asserted. For more information, refer to the Supply Controller (SUPC) and Electrical Characteristics sections of the datasheet.

10.2.3 Supply Monitor on VDDIO

The Supply Monitor monitors VDDIO. It is inactive by default. It can be activated by software and is fully programmable with 16 steps for the threshold (between 1.9V to 3.4V). It is controlled by the Supply Controller (SUPC). A sample mode is possible. It allows to divide the supply monitor power consumption by a factor of up to 2048. For more information, refer to the SUPC and Electrical Characteristics sections of the datasheet.

10.3 Reset Controller

The Reset Controller is based on a Power-on-Reset cell, and a Supply Monitor on VDDCORE.

The Reset Controller is capable to return to the software the source of the last reset, either a general reset, a wake-up reset, a software reset, a user reset or a watchdog reset.

The Reset Controller controls the internal resets of the system and the NRST pin input/output. It is capable to shape a reset signal for the external devices, simplifying to a minimum connection of a push-button on the NRST pin to implement a manual reset.

The configuration of the Reset Controller is saved as supplied on VDDIO.

10.4 Supply Controller (SUPC)

The Supply Controller controls the power supplies of each section of the processor and the peripherals (via Voltage regulator control)

The Supply Controller has its own reset circuitry and is clocked by the 32 kHz slow clock generator.

3 SAM3N Summary

The reset circuitry is based on a zero-power power-on reset cell and a brownout detector cell. The zero-power power-on reset allows the Supply Controller to start properly, while the software-programmable brownout detector allows detection of either a battery discharge or main voltage loss.

The Slow Clock generator is based on a 32 kHz crystal oscillator and an embedded 32 kHz RC oscillator. The Slow Clock defaults to the RC oscillator, but the software can enable the crystal oscillator and select it as the Slow Clock source.

The Supply Controller starts up the device by sequentially enabling the internal power switches and the Voltage Regulator, then it generates the proper reset signals to the core power supply.

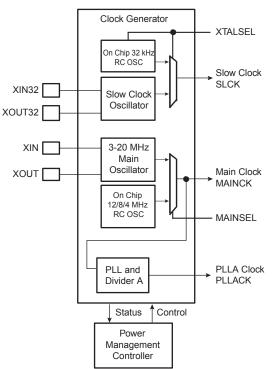
It also enables to set the system in different low power modes and to wake it up from a wide range of events.

10.5 Clock Generator

The Clock Generator is made up of:

- One Low Power 32768Hz Slow Clock Oscillator with bypass mode
- One Low-Power RC Oscillator
- · One 3-20 MHz Crystal or Ceramic resonator Oscillator, which can be bypassed
- One Fast RC Oscillator factory programmed, 3 output frequencies can be selected: 4, 8 or 12 MHz. By default 4 MHz is selected.
- One 60 to 130 MHz programmable PLL, capable to provide the clock MCK to the processor and to the peripherals. The input frequency of PLL is from 3.5 to 20 MHz.

Figure 10-2. Clock Generator Block Diagram





- Multi-drive option enables driving in open drain
- Programmable pull up on each I/O line
- Pin data status register, supplies visibility of the level on the pin at any time
- Selection of the drive level
- Synchronous output, provides Set and Clear of several I/O lines in a single write

11. Peripherals

11.1 Peripheral Identifiers

Table 11-1 defines the Peripheral Identifiers of the SAM3N4/2/1/0/00. A peripheral identifier is required for the control of the peripheral interrupt with the Nested Vectored Interrupt Controller and for the control of the peripheral clock with the Power Management Controller.

Table 11-1. Peripheral Identifiers

Instance ID	Instance Name	NVIC Interrupt	PMC Clock Control	Instance Description	
0	SUPC	X		Supply Controller	
1	RSTC	X		Reset Controller	
2	RTC	X		Real Time Clock	
3	RTT	X		Real Time Timer	
4	WDT	X		Watchdog Timer	
5	PMC	X		Power Management Controller	
6	EEFC	X		Enhanced Flash Controller	
7	-	-		Reserved	
8	UART0	X	X	UART 0	
9	UART1	X	X	UART 1	
10	-	-	-	Reserved	
11	PIOA	X	X	Parallel I/O Controller A	
12	PIOB	X	X	Parallel I/O Controller B	
13	PIOC	X	X	Parallel I/O Controller C	
14	USART0	X	X	USART 0	
15	USART1	X	X	USART 1	
16	-	-	-	Reserved	
17	-	-	-	Reserved	
18	-	-	-	Reserved	
19	TWIO	X	X	Two Wire Interface 0	
20	TWI1	x	X	Two Wire Interface 1	
21	SPI	X	X	Serial Peripheral Interface	
22	-	-	-	Reserved	
23	TC0	x	X	Timer/Counter 0	
24	TC1	X	X	Timer/Counter 1	





12. Embedded Peripherals Overview

12.1 Serial Peripheral Interface (SPI)

- Supports communication with serial external devices
 - Four chip selects with external decoder support allow communication with up to 15 peripherals
 - Serial memories, such as DataFlash and 3-wire EEPROMs
 - Serial peripherals, such as ADCs, DACs, LCD Controllers, CAN Controllers and Sensors
 - External co-processors
- · Master or slave serial peripheral bus interface
 - 8- to 16-bit programmable data length per chip select
 - Programmable phase and polarity per chip select
 - Programmable transfer delays between consecutive transfers and between clock and data per chip select
 - Programmable delay between consecutive transfers
 - Selectable mode fault detection
- · Very fast transfers supported
 - Transfers with baud rates up to MCK
 - The chip select line may be left active to speed up transfers on the same device

12.2 Two Wire Interface (TWI)

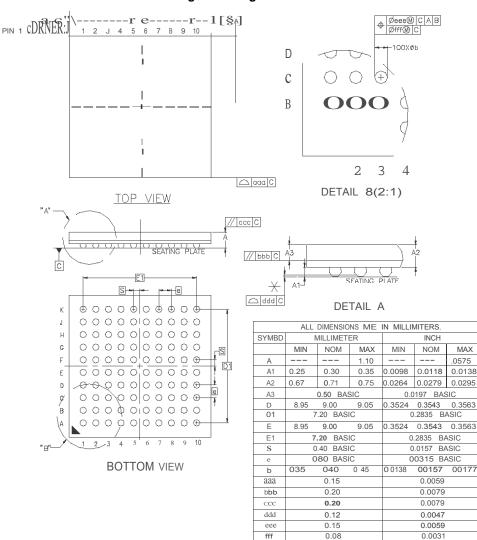
- Master, Multi-Master and Slave Mode Operation
- · Compatibility with Atmel two-wire interface, serial memory and I²C compatible devices
- One, two or three bytes for slave address
- · Sequential read/write operations
- Bit Rate: Up to 400 kbit/s
- · General Call Supported in Slave Mode
- Connecting to PDC channel capabilities optimizes data transfers in Master Mode only (for TWI0 only)
 - One channel for the receiver, one channel for the transmitter
 - Next buffer support

12.3 Universal Asynchronous Receiver Transceiver (UART)

- Two-pin UART
 - Implemented features are 100% compatible with the standard Atmel USART
 - Independent receiver and transmitter with a common programmable Baud Rate Generator
 - Even, Odd, Mark or Space Parity Generation
 - Parity, Framing and Overrun Error Detection
 - Automatic Echo, Local Loopback and Remote Loopback Channel Modes

4 SAM3N Summary







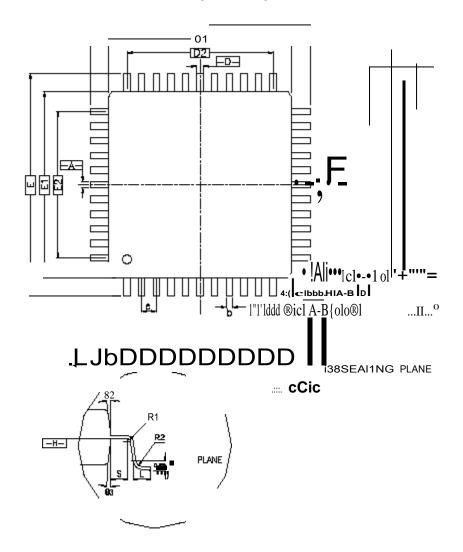


Figure 13-3. 64 and 4B · lead LQFP Package Drawing

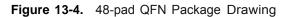


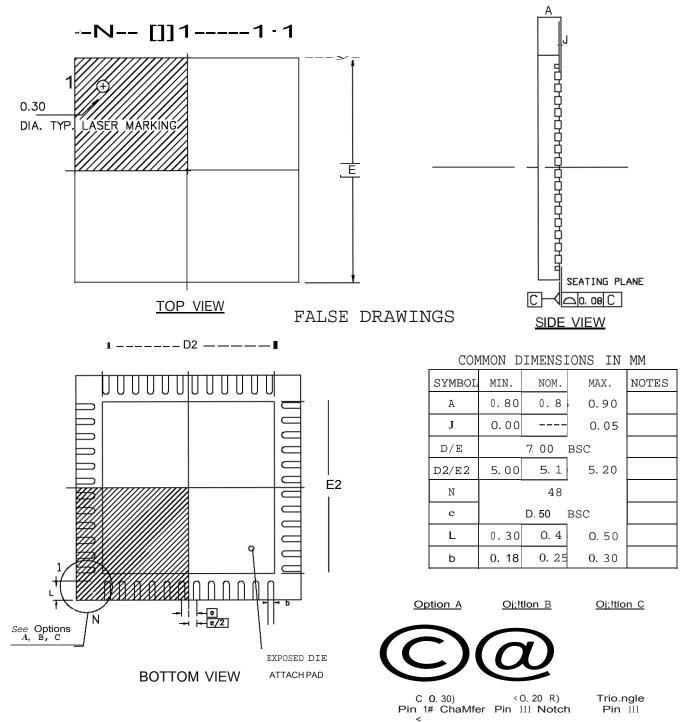
Symbol	Millimeter			Inch		
	Min	Nom	Max	Min	Nom	Max
А	-	_	1.60	_	-	0.063
A1	0.05	_	0.15	0.002	-	0.006
A2	1.35	1.40	1.45	0.053	0.055	0.057
D		12.00 BSC			0.472 BSC	
D1		10.00 BSC		0.383 BSC		
E	12.00 BSC		0.472 BSC			
E1	10.00 BSC				0.383 BSC	
R2	0.08	_	0.20	0.003	-	0.008
R1	0.08	_	-	0.003	-	-
q	0°	3.5°	7°	0°	3.5°	7°
θ1	0°	_	-	0°	-	-
θ2	11°	12°	13°	11°	12°	13°
θ3	11°	12°	13°	11°	12°	13°
С	0.09	_	0.20	0.004	-	0.008
L	0.45	0.60	0.75	0.018	0.024	0.030
L1	1.00 REF			0.039 REF		
S	0.20	_	-	0.008	-	-
b	0.17	0.20	0.27	0.007	0.008	0.011
е	0.50 BSC.		0.020 BSC.			
D2	7.50		0.285			
E2	7.50 0.285					
		Tolerance	es of Form and	d Position		
aaa	0.20		0.008			
bbb	0.20		0.008			
CCC	0.08		0.003			
ddd		0.08 0.003				

Table 13-2.	64-lead LQFP Package Dimensions (in mm)









s4 SAM3N Summary

Revision History

Doc. Rev. 11011BS	Comments	Change Request Ref.
	Overview:	
	All mentions of 100-ball LFBGA changed into 100-ball TFBGA	8044
	Section 8. "Product Mapping", Heading was 'Memories'. Changed to 'Product Mapping'	7685
	Section 4.1.4 "100-ball TFBGA Pinout", whole pinout table updated	7201
	Updated package dimensions in 'Features'	7965

Doc. Rev	Comments	Change Request Ref.
11011AS	First issue	